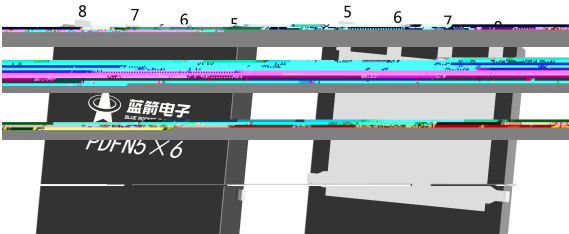
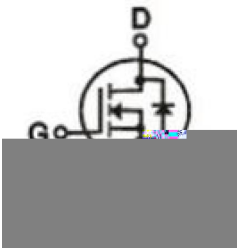


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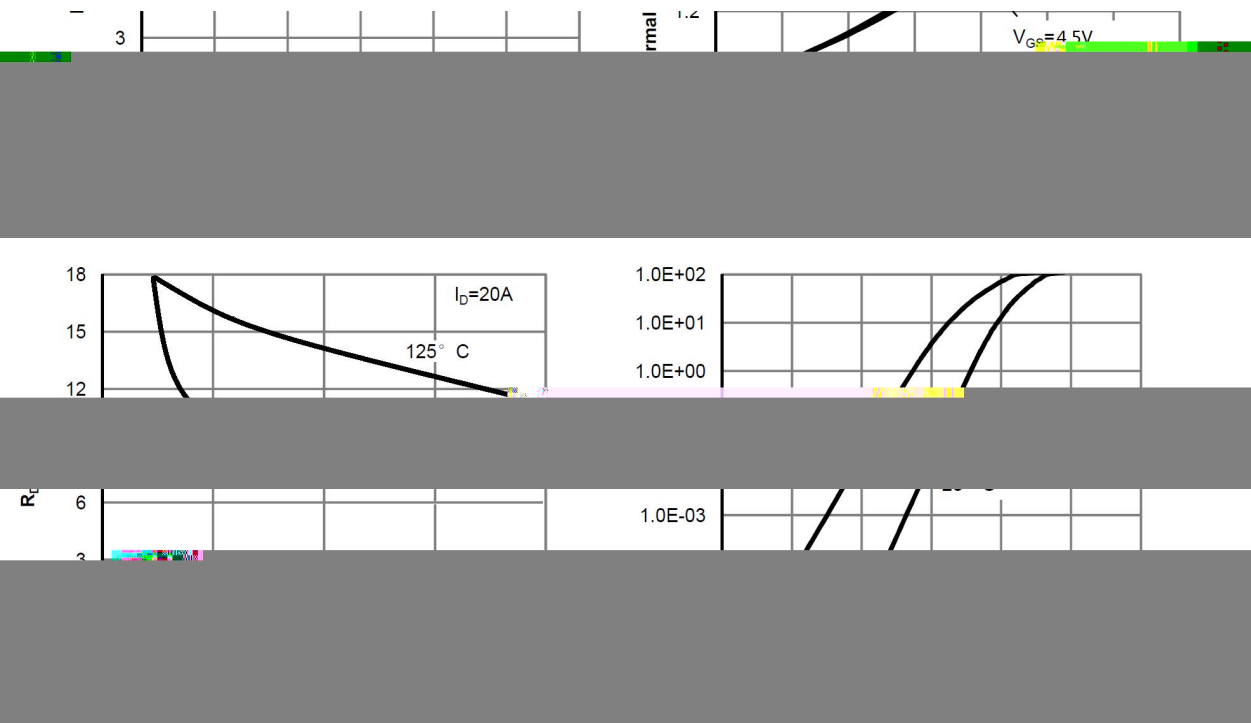
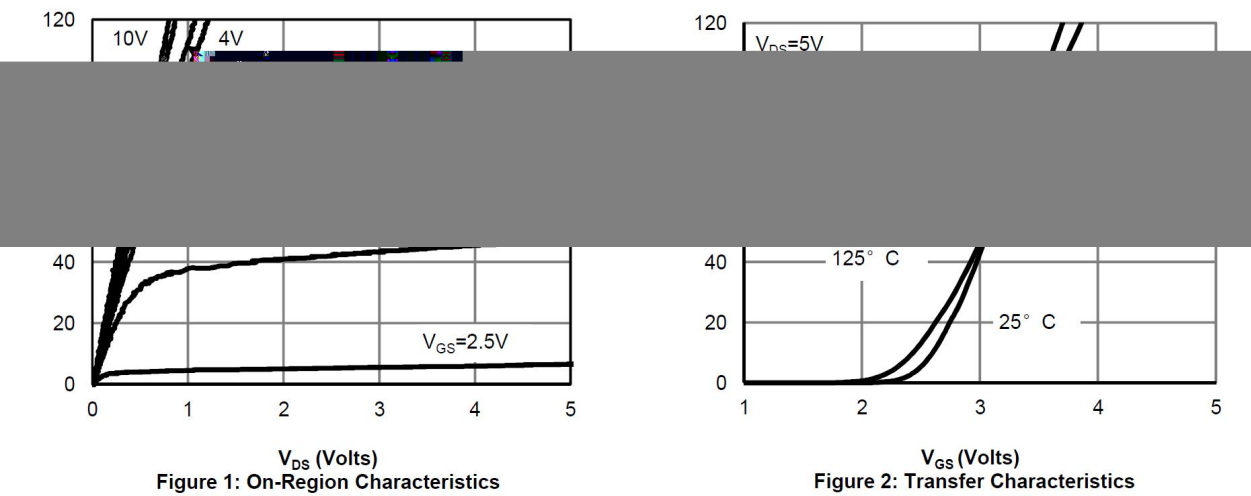
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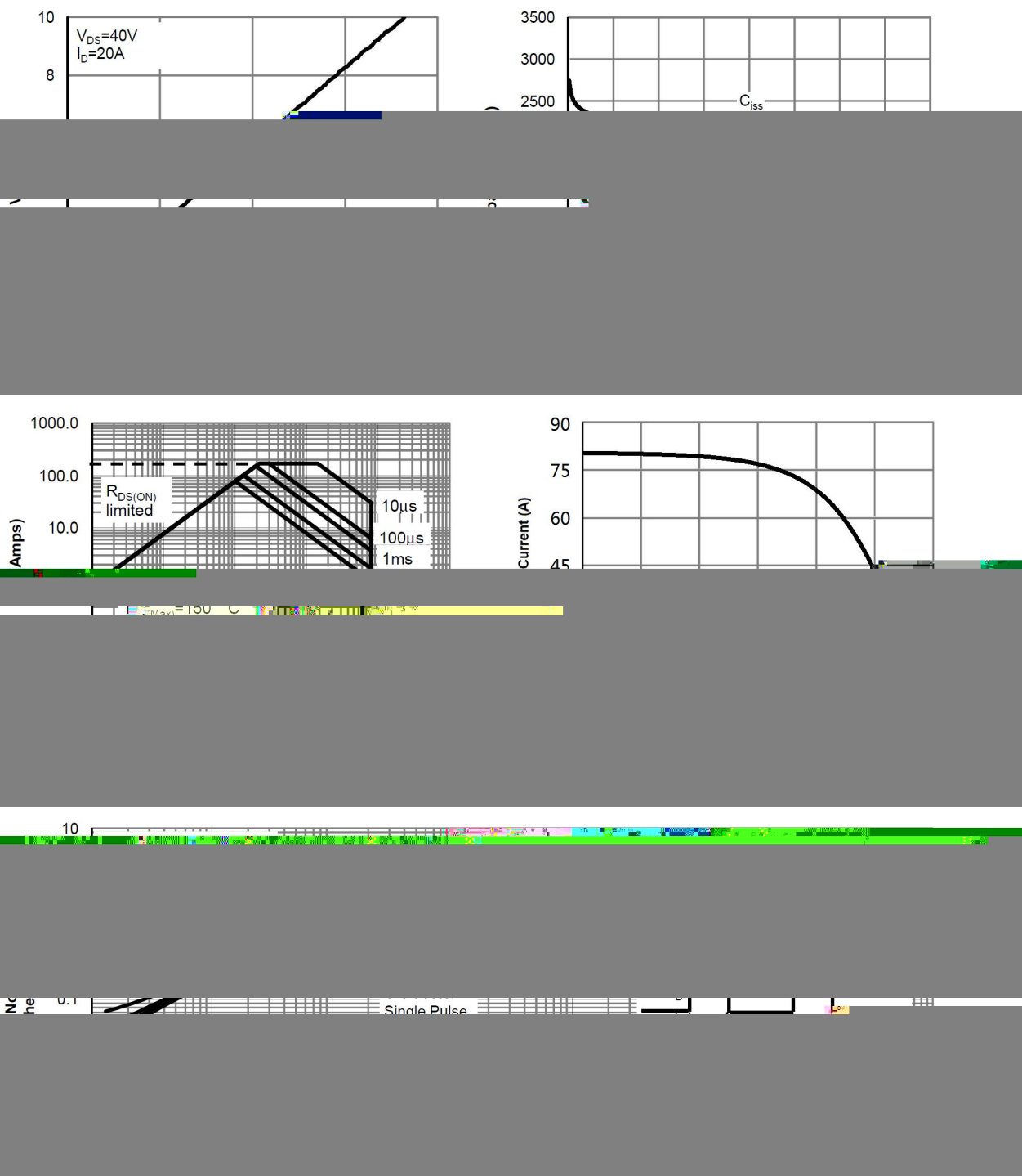
/ Electrical Characteristics(Ta=25 )

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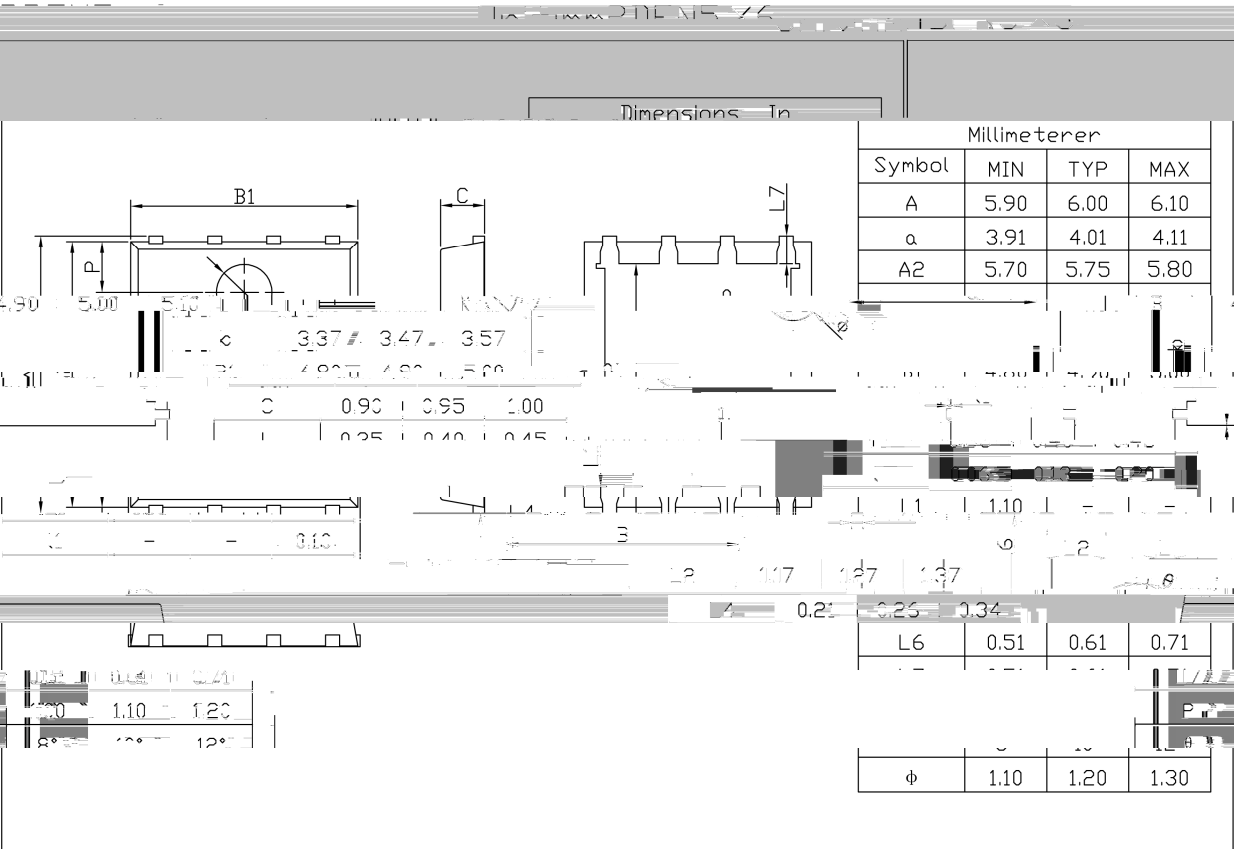
/ Electrical Characteristic Curve



/ Electrical Characteristic Curve

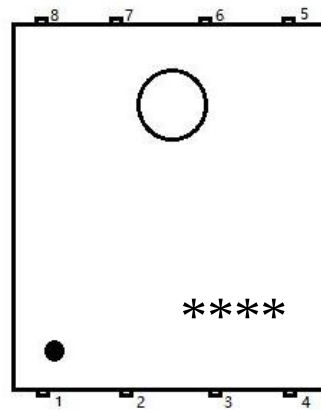


/ Package Dimensions



Rev.00 201812

/ Marking Instructions

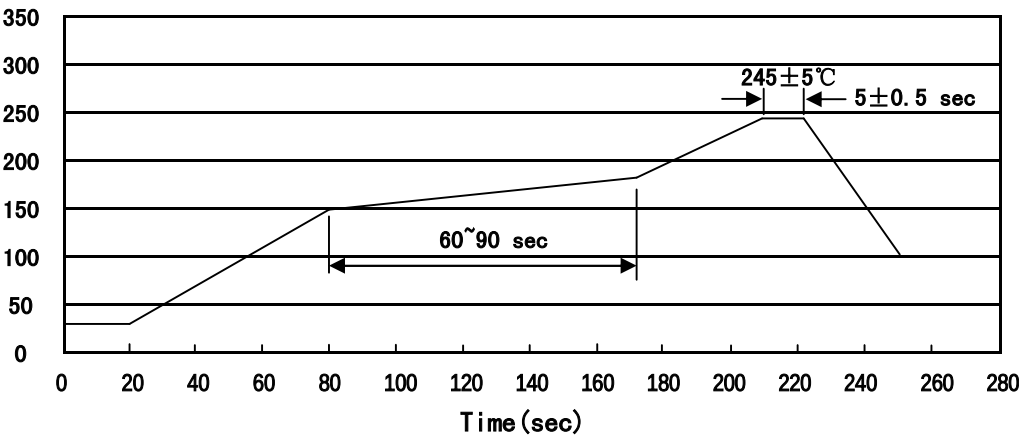


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(     ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± °C

± °C

± °C

± °C

/ Resistance to Soldering Heat Test Conditions

± °C

± °C

± °C

± °C

/ Packaging SPEC.

|   | 包装数量 |      |     |     |     | 包装尺寸 |   |   |
|---|------|------|-----|-----|-----|------|---|---|
|   | 只/卷盘 | 卷盘/盒 | 只/盒 | 盒/箱 | 只/箱 |      |   |   |
| × |      |      |     |     |     | ×    | × | × |

/ Notices